503046950 11/04/2014 PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date

MUNGAL SINGH DHANDA	08/01/2012
NIGEL PHILLIP ROBINSON	08/01/2012
AJIT GUPTA	08/23/2012
SIMON WALKE	08/01/2012
BHANU KIRAN JANGA	08/23/2012
VENKATA RAJI REDDY KANTHALA	08/23/2012
SUBBARAYUDU MUTYA	08/23/2012

RECEIVING PARTY DATA

Name: QUALCOMM Incorporated	
Street Address:	5775 Morehouse Drive
City:	San Diego
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14338122	

CORRESPONDENCE DATA

Fax Number:	(858)	(858)658-2502		
		e-mail address first; if that is unsuccessful, it will be sent nat is unsuccessful, it will be sent via US Mail.		
Phone:	(858)	651-5205		
Email:	us-docketing@qualcomm.com			
Correspondent Name:	QUA	QUALCOMM INCORPORATED		
Address Line 1:	5775 MOREHOUSE DRIVE			
Address Line 4:	SAN DIEGO, CALIFORNIA 92121-1714			
ATTORNEY DOCKET NUME	ER:	112813C1		
NAME OF SUBMITTER				

ATTOMALT DOCKET NOMBEN.	11201301
NAME OF SUBMITTER:	MICHELLE SANFILIPPO
SIGNATURE:	/Michelle Sanfilippo/
DATE SIGNED:	11/04/2014
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Total Attachments: 8

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ASSIGNMENT

WHEREAS, WE,

- 1. Mungal Singh Dhanda, a citizen of United Kingdom, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Slough, GB,
- 2. Nigel Phillip Robinson, a citizen of United Kingdom, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Farnborough, GB,
- 3. Ajit Gupta, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Hyderabad, IN,
- 4. Simon Walke, a citizen of United Kingdom, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Basingstoke, GB,
- 5. Bhanu Kiran Janga, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Hyderabad, IN.
- Venkata Raji Reddy Kanthala, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Hyderabad, IN,
- Subbarayudu Mutya, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Hyderabad, IN,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **RECEIVING CELL BROADCAST (CB) MESSAGES** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/547,896, filed July 12, 2012, Qualcomm Reference No. 112813, and all provisional applications relating thereto, together

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with U.S. Provisional Application No(s). 61/508,528, filed July 15, 2011, Qualcomm Reference No. 112813P1, together with U.S. Provisional Application No(s). 61/599,205, filed February 15, 2012, Qualcomm Reference No. 113261P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, confirmation applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT QUALCOMM Ref. No. 112813 Page 3 of 4

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	υĸ	, on <u> Ava 2012</u> Date	Most
	LOCATION	DATE	Mungal Singh Dhanda
		<u>, on / AUG 20</u> (2 DATE	~~~/_~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~
Done at _	LOCATION	, on DATE	Ajit Gupta
Done at _	LOCATION	, on	Simon Walke
Done at	LOCATION	, on DATE	Bhanu Kiran Janga

PATENT QUALCOMM Ref. No. 112813 Page 4 of 4

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Done at		_, on		
	LOCATION		DATE	Venkata Raji Reddy Kanthala
Done at		. 08		
20010 ut	LOCATION		DATE	Subbarayudu Mutya

PATENT QUALCOMM Ref. No. 112813 Page 1 of 4

ASSIGNMENT

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- 4. Simon Walke, a citizen of United Kingdom, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Basingstoke, GB,
- 5. Bhanu Kiran Janga, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Hyderabad, IN,
- Venkata Raji Reddy Kanthala, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Hyderabad, IN,
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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **RECEIVING CELL BROADCAST (CB) MESSAGES** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). **13/547,896**, filed **July 12, 2012**, Qualcomm Reference No. **112813**, and all provisional applications relating thereto, together

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with U.S. Provisional Application No(s). **61/508,528**, filed **July 15, 2011**, Qualcomm Reference No. **112813P1**, together with U.S. Provisional Application No(s). **61/599,205**, filed **February 15, 2012**, Qualcomm Reference No. **113261P1**, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT QUALCOMM Ref. No. 112813 Page 3 of 4

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	· · · · · · · · · · · · · · · · · · ·	, on	
	LOCATION	DĂTE	Mungal Singh Dhanda
Done at		, on DATE	
	LOCATION	DATE	Nigel Phillip Robinson
	<u>.</u>		C They
Done at	HYDERABAD	, on <u>23</u> Aug 2017	A A
Dono at	LOCATION	DATE DATE	Ajit Gupta
Done at		, on	
	LOCATION	DATE	Simon Walke
Done at	HYDEEASAD , MDI	on <u>8/23/2012</u>	3 Brow Dirac
	LOCATION	DATE	Bhanù Kiran Janga

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PATENT QUALCOMM Ref. No: 112813 Page 4 of 4

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Hyderabod INDIA Done at,	on 8/23/2012	JC.V. esienoy
LOCATION	DATE	Venkata Raji Reddy Kanthala
HYDERAGAR, Done at <u>ENDIA</u> ,	on 8/23/2012	Mile
LOCATION	DATE	Subbarayudu Mutya
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		×

RECORDED: 11/04/2014